ASSOCIATION CONNECTINI ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					nterials and	ials and Mfg Information				
upplier Inform	ation						·								
Company name*			Company unique ID			Ţ	Unique ID Authority					Response Date*			
nsemi											2023-0	2023-06-12			
Contact Name			Title - Contact			I	Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewa	rds		Product Enviro Compliance]	NA				Prod	Product-Env-Stewards@onsemi.com			
uthorized Represe	ntative*		Title - Representative			I	Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance			1	NA				Prod	Product-Env-Stewards@onsemi.com			
Requeste	r Item Number			Mfr Item Name 8SO 2-CH TR VDE			Effective Dat	e Vers	sion	Manufacturing Site		Weight*	UOM	Unit Type	
							2023-06-12 THH			146.043	mg	Each			
Ianufacturing	Proccess Informatio	n												·	
Terminal Plating / Grid Array Material T		Ferminal Base Alloy J-STD-020 MS		SL Rating	Peak Process Body Temper		ly Temperatu	ture Max Time at Peak Temper		rature Numb	er of Reflow Cy	eles			
Matte Tin (Sn) - annealed			CU Alloy 1				260 C 30		sec	seconds 3					
omments															
vel 1 - maximum ti	ime at peak temperature	during sol	dering is 10-3	30 seconds											
or more informatio	on regarding material co	mposition p	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Sta											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	aterial Weight Unit of Measure Level Substance		CAS	Exempt	Weight	Unit of Measure		
Coupling Gel	14.86	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.1633	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		14.6967	mg
Die	4.043	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.283	mg
			Supplier	Silicon (Si)	7440-21-3		3.76	mg
Die Attach	0.5	mg	Supplier	Silver (Ag)	7440-22-4		0.4	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.1	mg
Lead Frame	28.8	mg	Supplier	Silver (Ag)	7440-22-4		0.072	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0345	mg
			Supplier	Iron (Fe)	7439-89-6		0.6617	mg
			Supplier	Copper (Cu)	7440-50-8		28.023	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0088	mg
Mold Compound-White	97.443	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		3.8953	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		23.3521	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.9215	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		67.2741	mg
Plating	0.037	mg	Supplier	Tin (Sn)	7440-31-5		0.037	mg
Wire Bond - Au	0.36	mg	Supplier	Gold (Au)	7440-57-5		0.36	mg